



### Features

- Fast Switching Speed:  $t_{rr} \le 4.0$ ns
- Low Leakage Current: I<sub>R</sub> ≤ 25nA
- Low Capacitance: C<sub>T</sub> ≤ 4pF
- Flat Lead for High Thermal Efficiency
- Small Surface Mount Package
- Lead, Halogen and Antimony Free, RoHS Compliant (Note 1)
- "Green" Device (Note 2)
- Qualified to AEC-Q101 Standards for High Reliability

### **Mechanical Data**

- Case: SOD323F
- Case Material: Molded Plastic, "Green Molding Compound".
  UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: Cathode Band
- Terminals: Finish Matte Tin annealed over Copper Alloy leadframe. Solderable per MIL-STD-202, Method 208
- Weight: 0.007 grams (approximate)

#### SOD323F



Top View

### Ordering Information (Note 3)

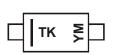
Part Number	Qualification	Case	Packaging
1N4448WSF-7	Commercial	SOD323F	3000/Tape & Reel
1N4448WSFQ-7	Automotive	SOD323F	3000/Tape & Reel

Notes: 1. No purposefully added lead. Halogen and Antimony Free.

2. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com.

3. For packaging details, go to our website at http://www.diodes.com.

# **Marking Information**



TK = Product Type Marking Code YM = Date Code Marking Y = Year (ex: Y = 2011) M = Month (ex: 9 = September)

#### Date Code Key

Year	2011		2012	2013		2014	2015		2016	2017		2018
Code	Y		Z	A		В	С		D	E		F
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



### Maximum Ratings @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit	
Non-Repetitive Peak Reverse Voltage	V <sub>RM</sub>	100	V	
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	75	V
RMS Reverse Voltage		V <sub>R(RMS)</sub>	53	V
Forward Continuous Current		I <sub>FM</sub>	500	mA
Average Rectified Output Current		lo	250	mA
Non-Repetitive Peak Forward Surge Current	@ t = 1.0µs @ t = 1.0s	I <sub>FSM</sub>	4 0.5	A

## **Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 4)	PD	400	mW
Thermal Resistance Junction to Ambient Air (Note 4)	$R_{ heta JA}$	313	°C/W
Operating and Storage Temperature Range	TJ, T <sub>STG</sub>	-65 to +150	°C

# Electrical Characteristics @T<sub>A</sub> = 25°C unless otherwise specified

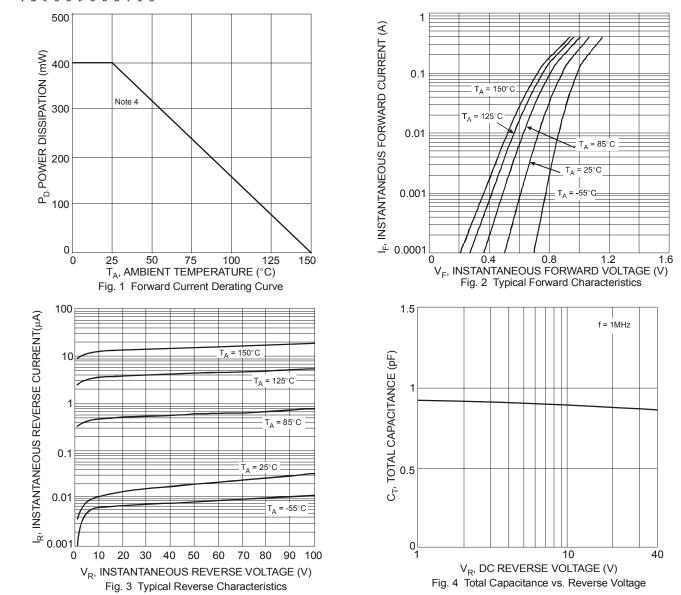
Characteristic	Symbol	Min	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 5)	V <sub>(BR)R</sub>	75	_	V	I <sub>R</sub> = 100μA
		0.62	0.72	v	I <sub>F</sub> = 5.0mA
Forward Voltage	V	_	0.855		I <sub>F</sub> = 10mA
Forward voltage	V <sub>F</sub>	_	1.0		I <sub>F</sub> = 100mA
		_	1.25		I <sub>F</sub> = 150mA
		_	2.5	μΑ	V <sub>R</sub> = 75V
Lookago Current (Noto E)		_	50	μA	V <sub>R</sub> = 75V, T <sub>J</sub> = 150°C
Leakage Current (Note 5)	IR	_	30	μΑ	V <sub>R</sub> = 25V, T <sub>J</sub> = 150°C
			25	nA	V <sub>R</sub> = 20V
Total Capacitance	CT	_	4.0	pF	V <sub>R</sub> = 0, f = 1.0MHz
Reverse Recovery Time	t <sub>rr</sub>	_	4.0	ns	$I_F = I_R = 10 \text{mA},$ $I_{rr} = 0.1 \text{ x } I_R, R_L = 100 \Omega$

Notes: 4. Part mounted on FR-4 PC board with minimum recommended pad layouts, which can be found on our website at http://www/diodes.com. 5. Short duration pulse test used to minimize self-heating.

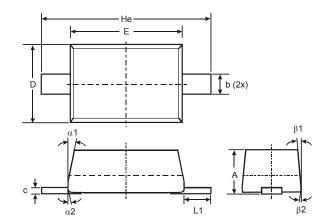
# 1N4448WSF



NEW PRODUCT



# **Package Outline Dimensions**

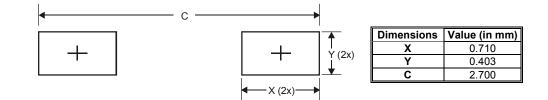


SOD323F						
Dim	Min	Тур				
Α	0.60	0.75	-			
b	0.25	0.35	-			
С	0.05	0.26	-			
D	1.15	1.35	1.25			
ш	1.60	1.80	1.70			
He	2.30	2.70	2.50			
L1	0.30	0.50	0.40			
α1	-	-	7°			
α2	_	_	3°			
β1	_	_	7°			
β2	-	-	3°			
All Dimensions in mm						

1N4448WSF Document number: DS35380 Rev. 3 - 2



## **Suggested Pad Layout**



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